

TA8190F, TA8191F

CD FOCUS TRACKING SERVO LSI

The TA8190F, TA8191F is a 3-beam type PUH compatible focus tracking servo LSIs to be used in the CD player system.

In combination with a CMOS single chip processor TC9236AF, a CD player system can be composed very simply.

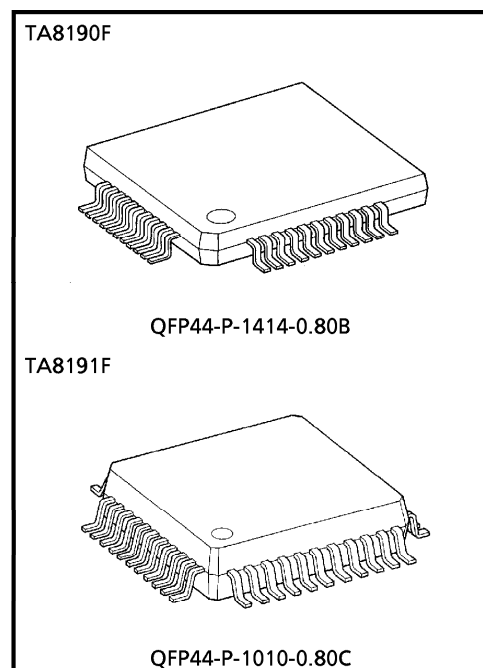
FEATURES

- Built-in RF amp, focus error amp, and tracking error amp.
- Built-in focus tracking servo amp.
- Built-in phase compensation amp and LPF amp.
(Regarding these amp, the pin connection differs between the TA8190F and the TA8191F.)
- Built-in ALPC amp.
- Connections between PUH and power driver IC for motor driver allow simplified structuring of CD player system.

TA8190F : Directly connectable to a transistor push-pull or power driver (TA8212F).

TA8191F : Directly connectable to BTL amp (TA8192F) or PWM driver (TA8460F).

- Differences between TA8190F and TA8191F are as follows :

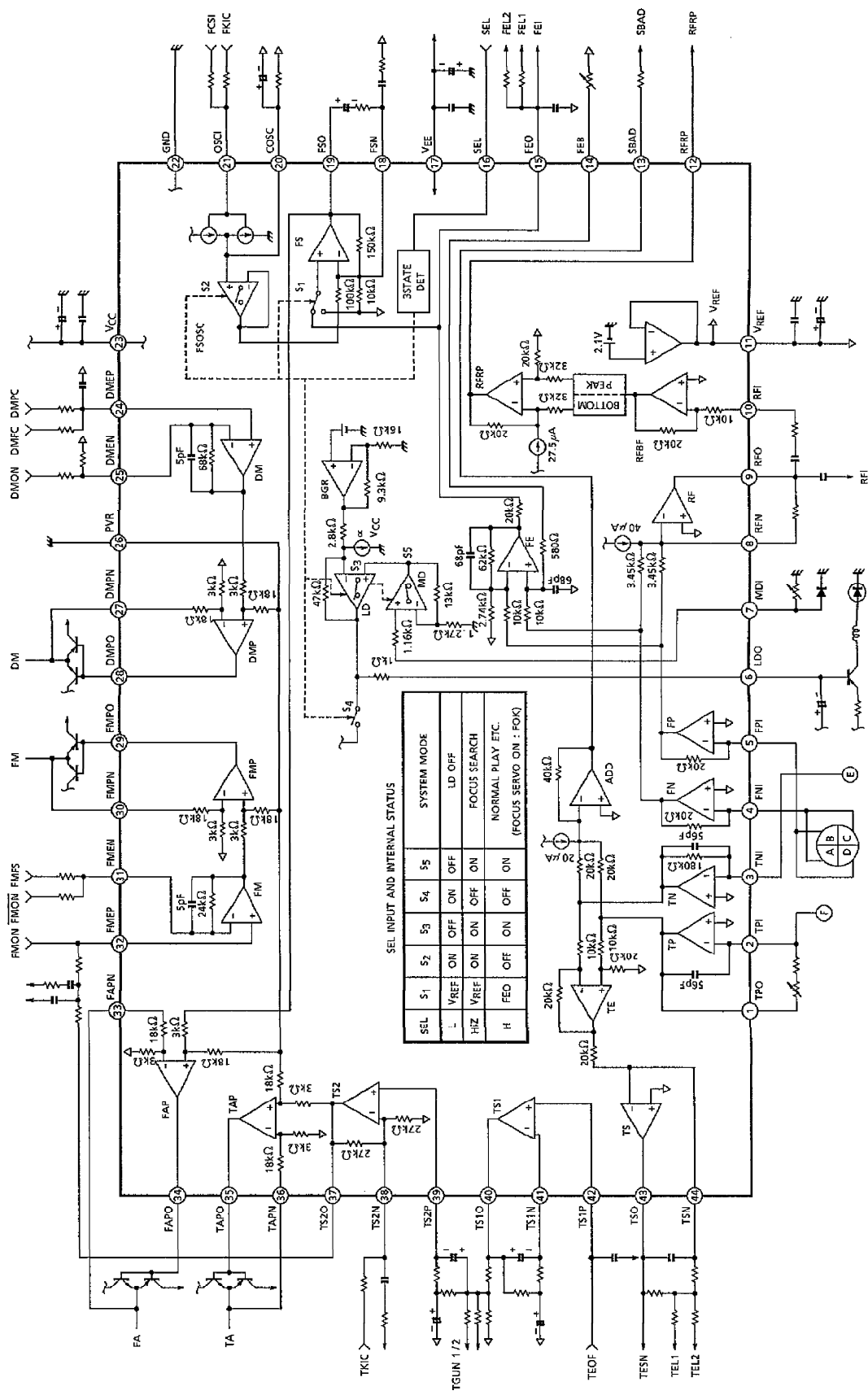


Weight
QFP44-P-1414-0.80B : 1.15g (Typ.)
QFP44-P-1010-0.80C : 0.5g (Typ.)

MODEL	REFERENCE VOLTAGE TERMINAL		PACKAGE (FLAT PACKAGE 44 PIN)	POWER SUPPLY	APPLICATION
	VREF	2VREF			
TA8190F	Yes	No	QFP44-P-1414B	± 5V double power supply	CD player
TA8191F	Yes	Yes	QFP44-P-1010C	+ 5V single power supply	Portable CD player Radio-cassette CD player

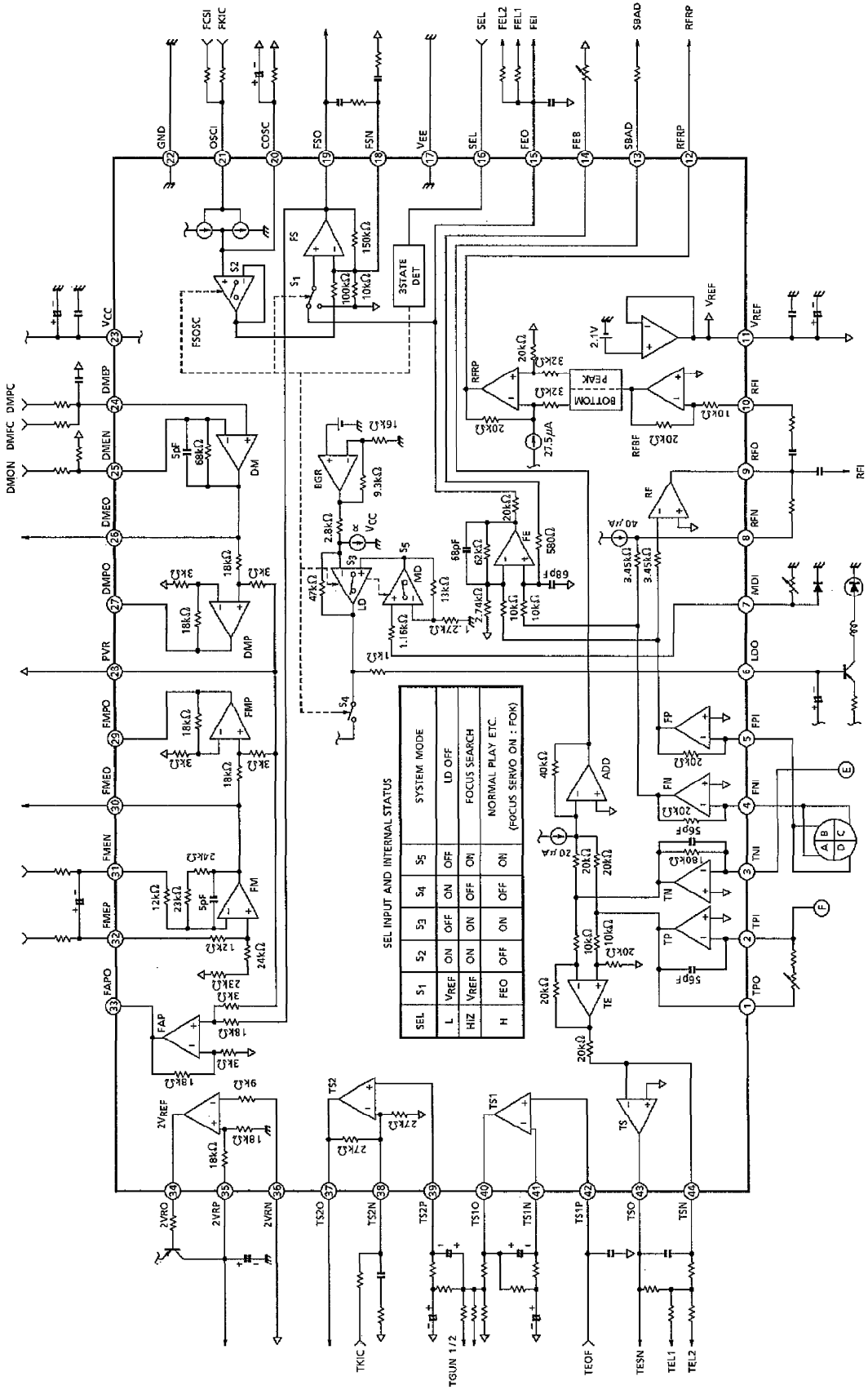
(VREF = 2.1V, 2VREF = 4.2V)

BLOCK DIAGRAM
TA8190F



TA8190,91F-2

BLOCK DIAGRAM
TA8191F



TA8190F,91F-3

PIN FUNCTION
 (Common)

PIN No.	SYMBOL	I/O	FUNCTIONAL DESCRIPTION	REMARKS
1	TPO	O	Sub-beam I-V amp (TP AMP) output terminal.	Connected to TPI through adjusting feedback resistor.
2	TPI	I	Sub-beam I-V amp (TP AMP) input terminal.	Connected to PIN diode F.
3	TNI	I	Sub-beam I-V amp (TN AMP) input terminal.	Connected to PIN diode E.
4	FNI	I	Main-beam I-V amp (FN AMP) input terminal.	Connected to PIN diode A + C.
5	FPI	I	Main-beam I-V amp (FP AMP) input terminal.	Connected to PIN diode B + D.
6	LDO	O	Laser diode amp (LD AMP) input terminal.	Connected to laser diode circuit.
7	MDI	I	Monitor photo diode amp (MD AMP) input terminal.	Connected to monitor photo diode.
8	RFN	I	RF amp (RF AMP) negative phase input terminal.	Connected to RFO through feedback resistor.
9	RFO	O	RF amp (RF AMP) output terminal.	—
10	RFI	I	RF ripple signal generating circuit input terminal.	Connected to RFO through CR.
11	VREF	O	Reference voltage supply output terminal. (+2.1V)	—
12	RFRP	O	RF ripple signal output terminal.	—
13	SBAD	O	Defects detection signal output terminal.	—
14	FEB	I	Focus error balance adjusting input terminal.	Adjusting semi-fixed resistor connected.
15	FEO	O	Focus error amp (FE AMP) output terminal.	Gain adjusting resistor is connected.
16	SEL	I	Analog switch control signal input terminal.	—
17	V _{EE}	—	Power source terminal. (TA8190F : -5V, TA8191F : GND)	—
18	FSN	I	Focus output amp (FS AMP) negative phase input terminal.	Connected to FSO through feedback CR.
19	FSO	O	Focus output amp (FS AMP) output terminal.	—
20	COSC	O	Focus search signal generating capacitor connecting terminal.	CR is connected.
21	OSCI	I	Focus search signal generating built-in current source control input terminal.	—
22	GND	—	Ground terminal.	—

(Common)

PIN No.	SYMBOL	I/O	FUNCTIONAL DESCRIPTION	REMARKS
23	V _{CC}	—	Power source terminal. (+5V)	—
24	DMEP	I	Disc motor amp (DM AMP) positive phase input terminal.	—
25	DMEN	I	Disc motor amp (DM AMP) negative phase input terminal.	—
31	FMEN	I	Feed motor amp (FM AMP) negative phase input terminal.	—
32	FMEP	I	Feed motor amp (FM AMP) positive phase input terminal.	—
37	TS2O	O	Tracking servo amp 2 (TS2 AMP) output terminal.	—
38	TS2N	I	Tracking servo amp 2 (TS2 AMP) negative phase input terminal.	—
39	TS2P	I	Tracking servo amp 2 (TS2 AMP) positive phase input terminal.	—
40	TS1O	O	Tracking servo amp 1 (TS1 AMP) output terminal.	—
41	TS1N	I	Tracking servo amp 1 (TS1 AMP) negative phase input terminal.	Connected to TS1O through feedback CR.
42	TS1P	I	Tracking servo amp 1 (TS1 AMP) positive phase input terminal.	—
43	TSO	O	Tracking output amp (TS AMP) output terminal.	—
44	TSN	I	Tracking output amp (TS AMP) negative phase input terminal.	Connected to TSO through feedback CR.

(TA8190F)

PIN No.	SYMBOL	I/O	FUNCTIONAL DESCRIPTION	REMARKS
26	PVR	I	Driving amp reference voltage input terminal.	Connect to GND.
27	DMPN	I	Disc motor driving amp (DMP AMP) negative phase input terminal.	—
28	DMPO	O	Disc motor driving amp (DMP AMP) output terminal.	Connected to DMPN through external output Tr.
29	FMPO	O	Feed motor driving amp (FMP AMP) output terminal.	Connected to EMPN through external output Tr.
30	FMPN	I	Feed motor driving amp (FMP AMP) negative phase input terminal.	—
33	FAPN	I	Focus actuator driving amp (FAP AMP) negative phase input terminal.	—
34	FAPO	O	Focus actuator driving amp (FAP AMP) output terminal.	Connected to FAPN through external output Tr.
35	TAPO	O	Tracking actuator driving amp (TAP AMP) output terminal.	Connected to TAPN through external output Tr.
36	TAPN	I	Tracking actuator driving amp (TAP AMP) negative phase input terminal.	—

(TA8191F)

PIN No.	SYMBOL	I/O	FUNCTIONAL DESCRIPTION	REMARKS
26	DMEO	O	Disc motor amp (DM AMP) output terminal.	—
27	DMPO	O	Disc motor driving amp (DM AMP) output terminal.	—
28	PVR	I	Driving amp reference voltage input terminal.	Connected to V_{REF} .
29	FMPO	O	Feed motor driving amp (FMP AMP) output terminal.	—
30	FMEO	O	Feed motor amp (FM AMP) output terminal.	—
33	FAPO	O	Focus actuator driving amp (FAP AMP) output terminal.	—
34	2VRO	O	2V _{REF} amp (2V _{REF} AMP) output terminal.	Connected to 2VRP through external output Tr.
35	2VRP	I	2V _{REF} amp (2V _{REF} AMP) positive phase input terminal.	—
36	2VRN	I	2V _{REF} amp (2V _{REF} AMP) negative phase input terminal.	—

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Power Supply Voltage		$V_{CC}-V_{EE}$	0.3~12.0	V
Power Dissipation	TA8190F	P_D	960 (*1)	mW
	TA8191F		780 (*2)	
Operating Temperature		T_{opr}	-25~75	°C
Storage Temperature		T_{stg}	-55~150	°C

(*1) Derated above 25°C in the proportion of 7.7mW/°C.

(*2) Derated above 25°C in the proportion of 6.2mW/°C.

ELECTRICAL CHARACTERISTICS

(Unless otherwise specified, TA8190F : $V_{CC}=5V$, $V_{EE}=-5V$, $T_a=25^\circ C$)
 TA8191F : $V_{CC}=5V$, $V_{EE}=GND$, $T_a=25^\circ C$)

CHARACTERISTIC		SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Power Source (TA8190F)	Power Supply Voltage	V_{CC}	—	$T_a = -25\sim 75^\circ C$	4.5	5.0	5.5	V
		V_{EE}	—		-5.5	-5.0	-4.5	
	Power Supply Current	I_{CC}	1	SEL = HiZ	14.0	24.0	32.0	mA
		I_{EE}	1	—	3.0	5.0	7.0	
Power Source (TA8191F)	Power Supply Voltage	V_{CC}	—	$T_a = -25\sim 75^\circ C$	4.5	5.0	5.5	V
	Power Supply Current	I_{CC}	3	—	14.0	24.0	32.0	mA
Reference Power Supply V_{REF} (Common)	Reference Voltage	V_{REF}	1, 3	—	1.95	2.10	2.25	V
	Reference Voltage Temperature Characteristic	$\Delta V / \Delta T$	1, 3	—	-3.0	-2.0	-1.0	mV/°C
	Output Current	I_{OH}	1, 3	—	5.0	—	—	mA
	Input Current	I_{OL}	1, 3	—	5.0	—	—	mA
FI ↓ RFO (Common)	Permissive Input Current	I_{IM}	1, 3	per each ch	30	—	—	μA
	Transfer Resistance	R_T	1, 3	f = 100kHz	115	127	140	kΩ
	Frequency Characteristic	f_c	2, 4	-3dB point	3.0	—	—	MHz
	Output Signal Slew Rate	SR	2, 4	$C_{RFO} = 20pF$	10	20	—	V/μs
	Total Harmonic Distortion	THD	1, 3	f = 100kHz $V_{REO} = 1.27V_{p-p}$	—	-40	-30	dB

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
FI ↓ RFO (Common)	Operation Reference Voltage	V _{OPR}	1, 3	V _{REF} reference	-1.13	-0.88	-0.72	V
	Upper Limit Output Voltage	V _{OH}	1, 3	V _{REF} reference	1.4	—	—	V
	Lower Limit Output Voltage	V _{OL}	1, 3	V _{REF} reference	—	—	-1.4	V
	Permissive Load Resistance	R _{LM}	—	—	10	—	—	kΩ
RFI ↓ RFRP (Common)	Input Operating Voltage	V _I	1, 3	—	0.8	—	1.6	V _{p-p}
	Voltage Gain	G _V	1, 3	f = 1kHz	0.55	0.62	0.69	V/V
	Peak Hold Frequency Characteristic	f _{CPD}	1, 3	—	60	120	240	kHz
	Bottom Hold Frequency Characteristics	f _{CBD}	1, 3	—	60	120	240	kHz
	Operation Reference Voltage 1	V _{OPR}	1, 3	V _{REF} reference	-0.61	-0.55	-0.49	V
	Operation Reference Voltage 2	V _{OPR}	1, 3	V _{REF} reference 700kHz, 1V _{p-p} input	-120	0	120	mV
	Permissive Load Resistance	R _{LM}	—	—	10	—	—	kΩ
FI ↓ FEO (Common)	Transfer Resistance	R _T	1, 3	f = 1kHz	97	124	151	kΩ
	Gain Balance	GB	1, 3	f = 1kHz	-1.5	—	1.5	dB
	Frequency Characteristic	f _c	1, 3	-3dB point	20	30	60	kHz
	Total Harmonic Distortion	THD	1, 3	f = 1kHz V _{FEO} = 1.7V _{p-p}	—	—	-40	dB
	Output Offset Voltage	V _{OS}	1, 3	V _{REF} reference	-100	—	100	mV
	Offset Voltage Drift	ΔV / ΔT	1, 3	—	-400	—	400	μV / °C
	Upper Limit Output Voltage	V _{OH}	1, 3	V _{REF} reference	1.5	—	—	V
	Lower Limit Output Voltage	V _{OL}	1, 3	V _{REF} reference	—	—	-1.5	V

CHARACTERISTIC		SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
TI ↓ TSO (Common)	Permissive Input Current	I _{IM}	1, 3	Per each ch	5.0	—	—	μA
	Transfer Resistance	R _T	1, 3	f = 1kHz	354	432	554	kΩ
	Gain Balance	GB	1, 3	f = 1kHz	− 2.0	—	2.0	dB
	Frequency Characteristic	f _c	1, 3	− 3dB point	10	16	30	kHz
	Total Harmonic Distortion	THD	1, 3	f = 1kHz V _{TSO} = 0.8V _{p-p}	—	—	− 40	dB
	Output Offset Voltage	V _{OS}	1, 3	V _{REF} reference	− 50	—	50	mV
	Offset Voltage Drift	ΔV / ΔT	1, 3	—	− 200	—	200	μV / °C
	Upper Limit Output Voltage	V _{OH}	1, 3	V _{REF} reference	1.5	—	—	V
	Lower Limit Output Voltage	V _{OL}	1, 3	V _{REF} reference	—	—	− 1.5	V
	Permissive Load Resistance	R _{LM}	—	—	10	—	—	kΩ
TI ↓ SBAD (Common)	Permissive Input Current	I _{IM}	1, 3	Total in both ch	7.0	—	—	μA
	Transfer Resistance	R _T	1, 3	f = 1kHz	280	360	440	kΩ
	Frequency Characteristic	f _c	1, 3	− 3dB point	10	16	30	kHz
	Total Harmonic Distortion	THD	1, 3	f = 1kHz V _{SBAD} = 1.6V _{p-p}	—	—	− 40	dB
	Operation Reference Voltage	V _{OPR}	1, 3	V _{REF} reference	− 0.88	− 0.80	− 0.72	V
	Upper Limit Output Voltage	V _{OH}	1, 3	V _{REF} reference	1.5	—	—	V
	Lower Limit Output Voltage	V _{OL}	1, 3	V _{REF} reference	—	—	− 1.5	V
	Permissive Load Resistance	R _{LM}	—	—	10	—	—	kΩ
OSCI ↓ FSO (Common)	Output Amplitude	V _O	—	f _{OSCI} = 0.5Hz (CMOS level)	610	700	780	mV _{p-p}
	Output Offset Voltage	V _{OS}	—	OSCI : HiZ	− 35	—	35	mV
	Output Switch Isolation	V _{ISO}	—	f _{OSCI} = 0.5Hz SEL : "H" level	—	—	25	mV _{p-p}

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
FEO ↓ FSO (TA8190F)	Voltage Gain 1	G _{V1}	—	f = 10kHz V _{FSO} = 1V _{p-p}	14.5	16.0	17.5	V / V
	Voltage Gain 2	G _{V2}	—	R _{NF} (FSO-FSN) : 12kΩ	1.79	2.11	2.43	V / V
	Upper Limit Output Voltage	V _{OH}	—	GND reference	3.6	—	—	V
	Lower Limit Output Voltage	V _{OL}	—	GND reference	—	—	0.5	V
	Output Offset Voltage	V _{OS}	—	—	− 32	—	32	mV
	Total Harmonic Distortion	THD	—	f = 10kHz V _{FSO} = 1V _{p-p}	—	—	− 40	dB
FEO ↓ FSO (TA8191F)	Voltage Gain 1	G _{V1}	—	f = 10kHz V _{FSO} = 1V _{p-p}	14.5	16.0	17.5	V / V
	Voltage Gain 2	G _{V2}	—	R _{NF} (FSO-FSN) : 12kΩ	1.79	2.11	2.43	V / V
	Upper Limit Output Voltage	V _{OH}	—	GND reference	3.6	—	—	V
	Lower Limit Output Voltage	V _{OL}	—	GND reference	—	—	0.5	V
	Output Offset Voltage	V _{OS}	—	—	− 32	—	32	mV
	Total Harmonic Distortion	THD	—	f = 10kHz V _{FSO} = 1V _{p-p}	—	—	− 40	dB
FEO ↓ FAPO (TA8190F)	Voltage Gain	G _V	—	f = 10kHz V _{FAPO} = 1V _{p-p}	80	96	114	V / V
	Upper Limit Output Voltage	V _{OH}	—	GND reference	2.8	—	—	V
	Lower Limit Output Voltage	V _{OL}	—	GND reference	—	—	− 2.8	V
	Output Offset Voltage	V _{OS}	—	—	− 200	—	200	mV
	Total Harmonic Distortion	THD	—	f = 10kHz V _{FAPO} = 1V _{p-p} R _L = 8Ω	—	—	− 40	dB

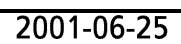
CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
FEO ↓ FAPO (TA8191F)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{FAPO} = 1V_{p-p}$	14.0	16.0	18.0	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	3.6	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	1.0	V
	Output Offset Voltage	V_{OS}	—	—	− 40	—	40	mV
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{FAPO} = 1V_{p-p}$	—	—	− 40	dB
TS1P ↓ TS1O (Common)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{TS1O} = 1V_{p-p}$	0.95	1.00	1.05	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	3.6	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	1.0	V
	Output Offset Voltage	V_{OS}	—	—	− 5.0	—	5.0	mV
	Input Bias Current	I_I	—	—	− 100	—	100	nA
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{TS1O} = 1V_{p-p}$	—	—	− 40	dB
TS2P ↓ TS2O (Common)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{TS2O} = 1V_{p-p}$	1.9	2.0	2.1	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	3.6	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	0.5	V
	Output Offset Voltage	V_{OS}	—	—	− 10	—	10	mV
	Input Bias Current	I_I	—	—	− 100	—	100	nA
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{TS2O} = 1V_{p-p}$	—	—	− 40	dB

CHARACTERISTIC		SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
TS2P ↓ TAPO (TA8190F)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{TAPO} = 1V_{p-p}$	10.5	12.0	13.5	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	2.8	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	-2.8	V
	Output Offset Voltage	V_{OS}	—	—	-80	—	80	mV
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{TAPO} = 1V_{p-p}$ $R_L = 8\Omega$	—	—	-40	dB
DMEP ↓ DMEO (TA8191F)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{DMEO} = 1V_{p-p}$	5.7	6.7	7.7	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	3.6	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	0.5	V
	Output Offset Voltage	V_{OS}	—	—	-15	—	15	mV
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{DMEO} = 1V_{p-p}$	—	—	-40	dB
DMEP ↓ DMPO (TA8190F)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{DMPO} = 1V_{p-p}$	32	40	50	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	2.8	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	-2.8	V
	Output Offset Voltage	V_{OS}	—	—	-100	—	100	mV
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{DMPO} = 1V_{p-p}$ $R_L = 8\Omega$	—	—	-35	dB

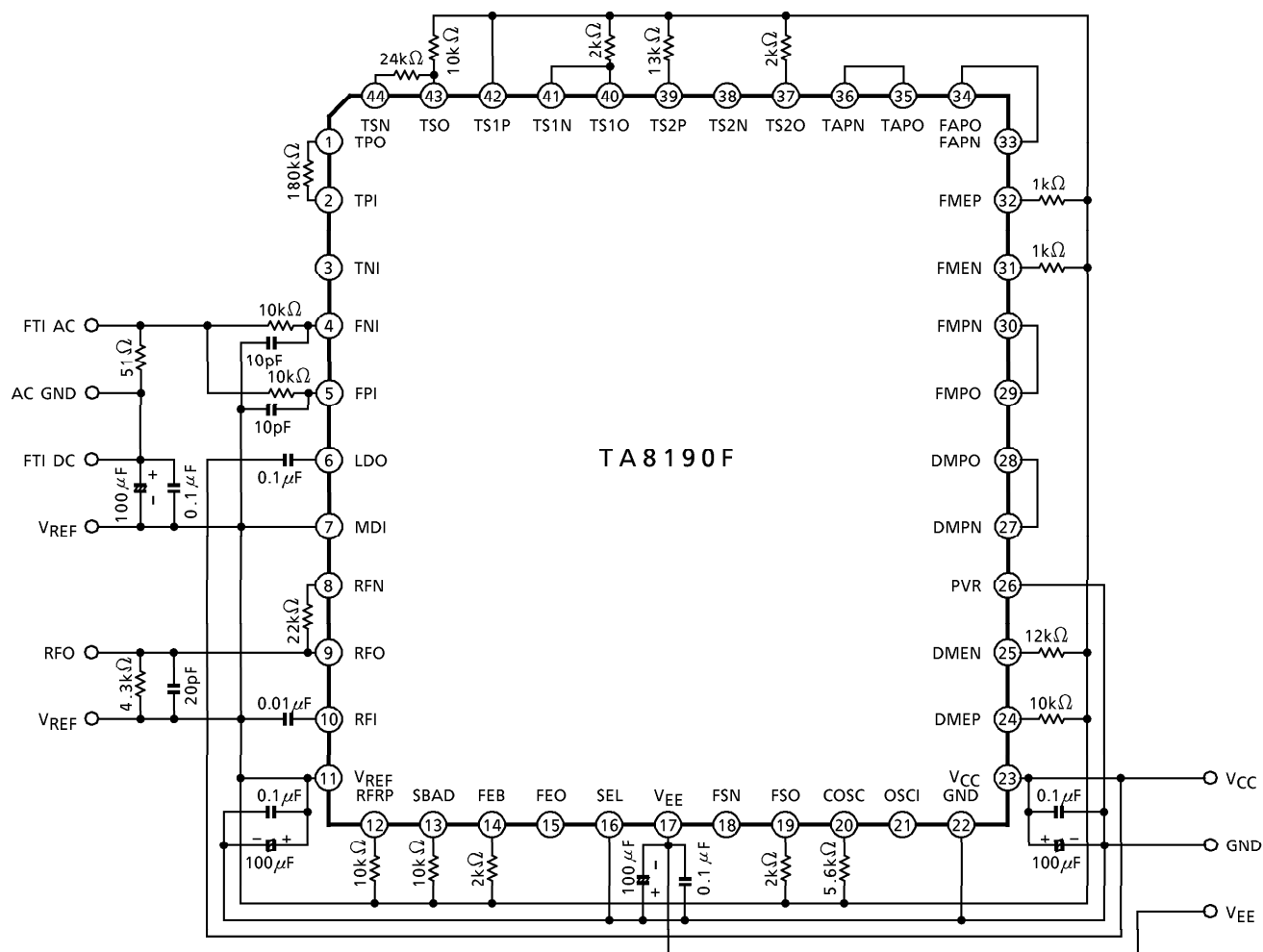
CHARACTERISTIC		SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
DMEP ↓ DMPO (TA8191F)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{DMPO} = 1V_{p-p}$	5.4	6.7	8.0	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	3.6	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	1.2	V
	Output Offset Voltage	V_{OS}	—	—	− 30	—	30	mV
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{DMPO} = 1V_{p-p}$	—	—	− 40	dB
FMEO ↓ FMPO (TA8191F)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{FMEO} = 1V_{p-p}$ $V_{FMEN} = V_{REF}$	3.6	3.9	4.3	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	3.6	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	0.5	V
	Output Offset Voltage	V_{OS}	—	—	− 15	—	15	mV
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{FMEO} = 1V_{p-p}$	—	—	− 40	dB
FMEO ↓ FMPO (TA8190F)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{FMPO} = 1V_{p-p}$	124	150	177	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	2.8	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	− 2.8	V
	Output Offset Voltage	V_{OS}	—	—	− 500	—	500	mV
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{FMPO} = 1V_{p-p}$ $R_L = 8\Omega$	—	—	− 30	dB

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
FMPEP ↓ FMPO (TA8191F)	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{FMPO} = 1V_{p-p}$ $V_{FMEN} = V_{REF}$	3.4	3.9	4.6	V / V
	Upper Limit Output Voltage	V_{OH}	—	GND reference	3.6	—	—	V
	Lower Limit Output Voltage	V_{OL}	—	GND reference	—	—	1.0	V
	Output Offset Voltage	V_{OS}	—	—	−20	—	20	mV
	Total Harmonic Distortion	THD	—	$f = 10\text{kHz}$ $V_{FMPO} = 1V_{p-p}$	—	—	−40	dB
2VRN ↓ 2VR (TA8191F)	DC Voltage Gain	G_{VDC}	—	$V_{2VR} = V_{REF}$	1.90	2.00	2.10	V / V
MDI ↓ LDO (Common)	Reference Operating Voltage	V_{MDI}	—	V_{MDI} at which V_{LDO} becomes 3.5V.	170	178	192	mV
	Voltage Gain	G_V	—	$f = 10\text{kHz}$ $V_{LDO} = 0.5V_{p-p}$	170	200	230	mV
	Input Bias Current	I_I	—	—	−200	—	200	nA
	Ripple Removing Ratio (With V_{CC})	RR	—	Input converted value	—	—	−56	dB
	Frequency Characteristic	f_c	—	−3dB point	20	—	—	kHz
	LD Off Voltage (With V_{CC})	$V_{LD\ OFF}$	—	SEL = L	−0.7	—	—	V

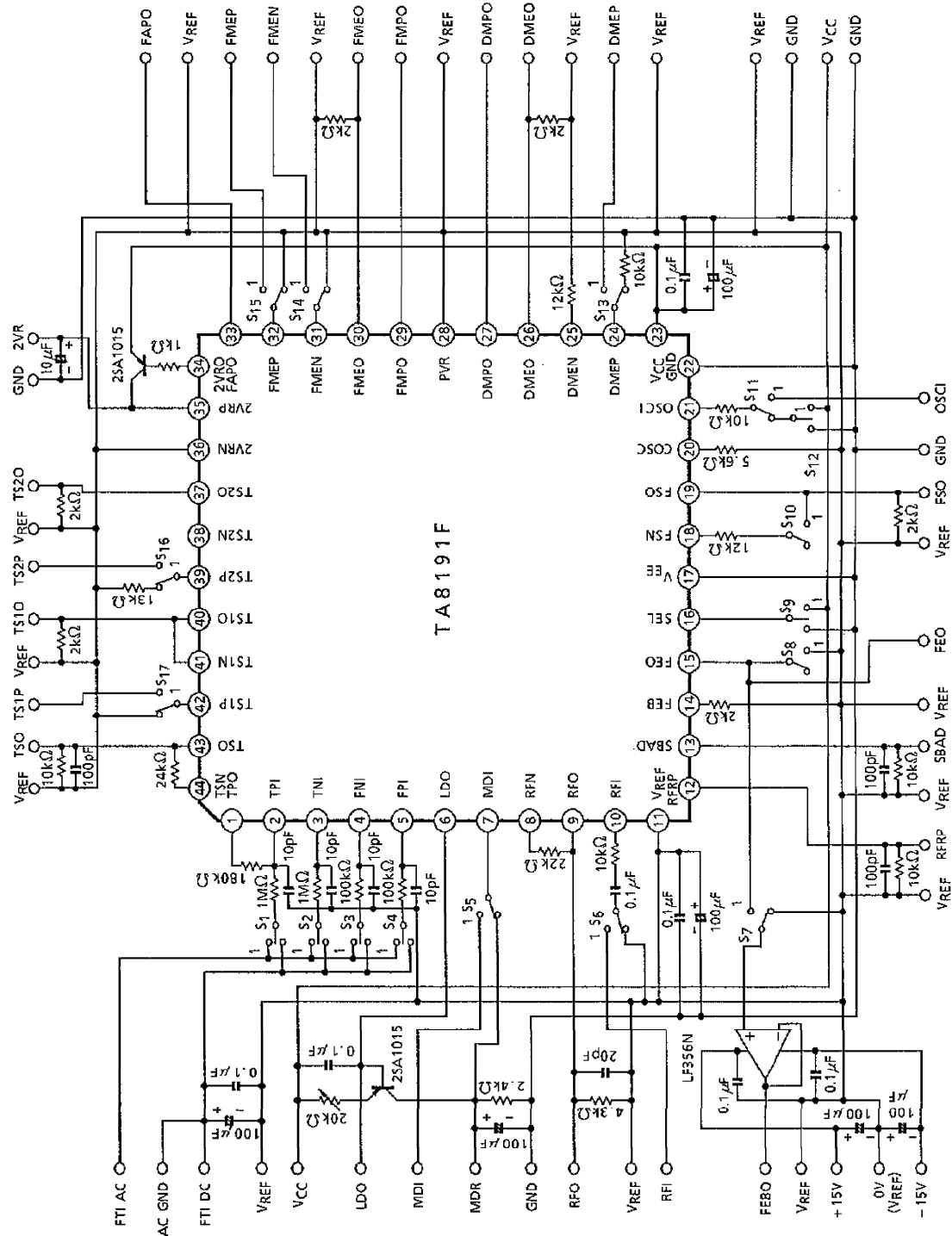
TA8190,91F-15



TEST CIRCUIT 2



TEST CIRCUIT 3



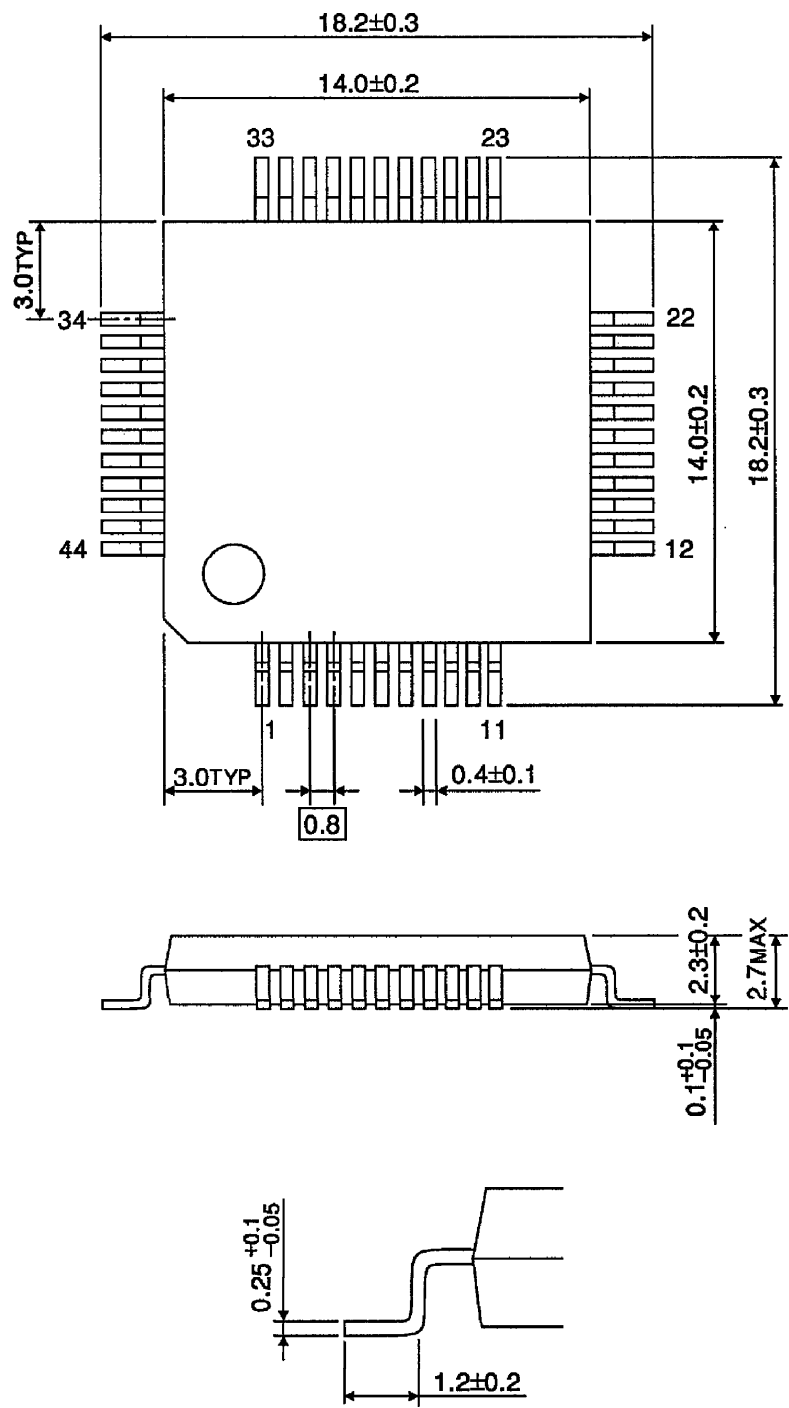
TA8190,91F-17

The diagram shows the pin configuration for the TA8191F IC, a 33-pin device. The pins are numbered 1 through 33. The functions and associated components for each pin are as follows:

- Pin 1: TSN TPO (180kΩ resistor to pin 2)
- Pin 2: TPI
- Pin 3: TNI
- Pin 4: FNI (10kΩ resistor to pin 5)
- Pin 5: FPI (10kΩ resistor to pin 4, 10pF capacitor to ground)
- Pin 6: LDO (0.1μF capacitor to ground)
- Pin 7: MDI
- Pin 8: RFN (22kΩ resistor to pin 9)
- Pin 9: RFO (4.3kΩ resistor to ground, 20pF capacitor to ground)
- Pin 10: RFI (0.01μF capacitor to ground)
- Pin 11: VREF RFRP (0.1μF capacitor to ground, 100μF capacitor to ground)
- Pin 12: SBAD (10kΩ resistor to ground)
- Pin 13: FEB (10kΩ resistor to ground)
- Pin 14: FEO (2kΩ resistor to ground)
- Pin 15: SEL
- Pin 16: VEE
- Pin 17: FSN
- Pin 18: FSO (2kΩ resistor to ground)
- Pin 19: COSC (5.6kΩ resistor to ground)
- Pin 20: OSC1
- Pin 21: VCC GND
- Pin 22: VCC GND (0.1μF capacitor to ground, 100μF capacitor to ground)
- Pin 23: VCC
- Pin 24: DMEP (10kΩ resistor to ground)
- Pin 25: DMEN (12kΩ resistor to ground)
- Pin 26: DME0 (2kΩ resistor to ground)
- Pin 27: DMPO
- Pin 28: PVR
- Pin 29: FMPO
- Pin 30: FME0 (2kΩ resistor to ground)
- Pin 31: FMEN
- Pin 32: FMEP
- Pin 33: 2SA1015 (1kΩ resistor to pin 34, 10μF capacitor to ground)

PACKAGE DIMENSIONS
QFP44-P-1414-0.80B

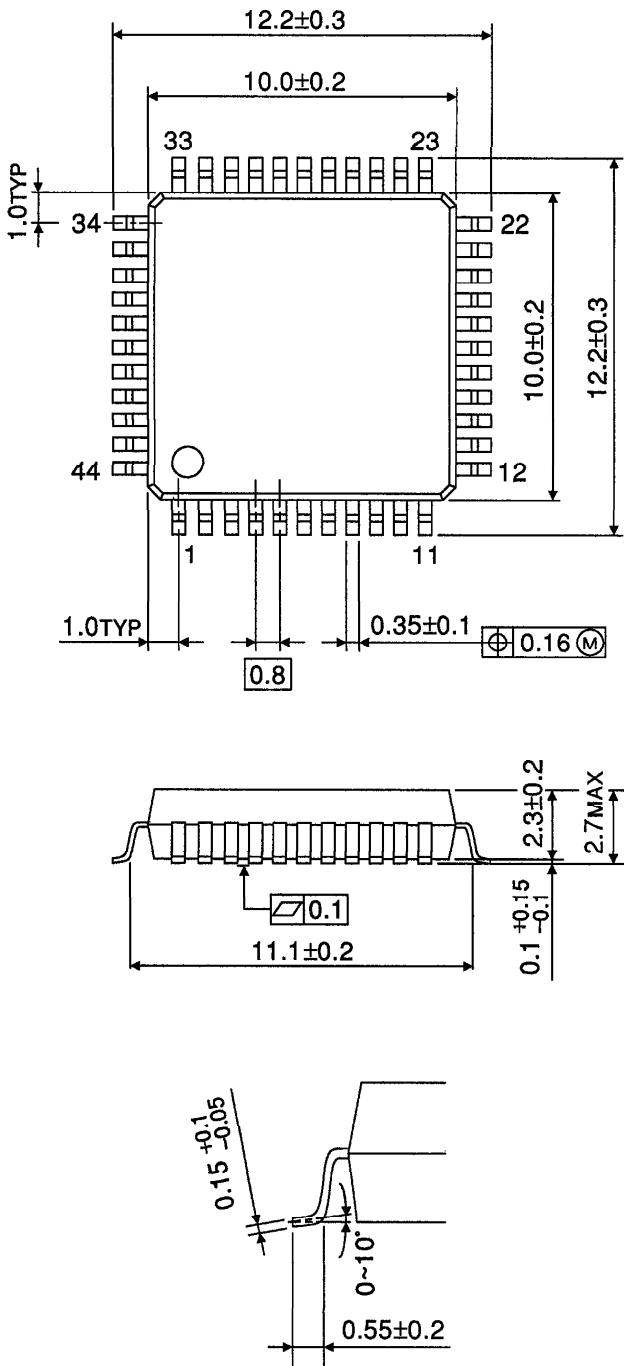
Unit : mm



Weight : 1.15g (Typ.)

PACKAGE DIMENSIONS
QFP44-P-1010-0.80C

Unit : mm



Weight : 0.5g (Typ.)

RESTRICTIONS ON PRODUCT USE

000707EBA

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.